

Image 1733

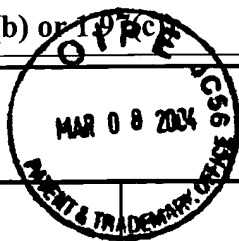
<b>TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT</b> (Under 37 CFR 1.97(b) or 1.97(c))			Docket No. 3816.09	
In Re Application Of: <b>Boyle et al.</b>				
Serial No. <b>10-097670,990</b>	Filing Date <b>September 25, 2003</b>	Examiner <b>unknown</b>	Group Art Unit <b>1733</b>	
Title: <b>Adhesive of a Silicon and Silica Composite Particularly Useful for Joining Silicon Parts</b>				
Address to: <b>Assistant Commissioner for Patents</b> <b>Washington, D.C. 20231</b>				
<b>37 CFR 1.97(b)</b>				
1. <input checked="" type="checkbox"/> The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application other than a continued prosecution application under 37 CFR 1.53(d); within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; before the mailing of a first Office Action on the merits, or before the mailing of a first Office Action after the filing of a request for continued examination under 37 CFR 1.114.				
<b>37 CFR 1.97(c)</b>				
2. <input type="checkbox"/> The Information Disclosure Statement submitted herewith is being filed after the period specified in 37 CFR 1.97(b), provided that the Information Disclosure Statement is filed before the mailing date of a Final Action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an Action that otherwise closes prosecution in the application, and is accompanied by one of:				
<div style="margin-left: 40px;"> <input type="checkbox"/> the statement specified in 37 CFR 1.97(e);         </div>				
<b>OR</b>				
<div style="margin-left: 40px;"> <input type="checkbox"/> the fee set forth in 37 CFR 1.17(p).         </div>				

**TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT**

(Under 37 CFR 1.97(b) or 1.97(c))

Docket No.  
3816.09

In Re Application: Boyle et al.



Serial No.

10 09/670,990

Filing Date

September 25, 2003

Examiner

unknown

Group Art Unit

1733

Adhesive of a Silicon and Silica Composite Particularly Useful for Joining Silicon Parts

**Payment of Fee**

(Only complete if Applicant elects to pay the fee set forth in 37 CFR 1.17(p))

- ☐ A check in the amount of \_\_\_\_\_ is attached.
- ☐ The Assistant Commissioner is hereby authorized to charge and credit Deposit Account No. 50-0636 as described below. A duplicate copy of this sheet is enclosed.
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Dated: February 23, 2004

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CC:

U.S. Department of Commerce, Patent and Trademark Office					Docket No.: <b>3816.09</b>			
					Serial No.: <b>10/670,990</b>			
LIST OF RELEVANT ART CITED BY APPLICANT					Applicant: <b>James E. BOYLE</b>			
(Use several sheets if necessary)					Filing Date: <b>September 25, 2003</b>			
					Group: <b>1733</b>			
U.S. PATENT DOCUMENTS								
*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	6,239,004	05/29/01	Aga et al.	438	455		
	AB	6,450,346	09/17/02	Boyle et al.	211	41.18	06/30/00	
	AC	6,544,864	04/08/03	Reeder et al.	438	455	08/22/01	
	AD							
	AE							
	AF							
	AG							
	AH							
FOREIGN PATENT DOCUMENTS (Translation)								
		Document Number	Date	Country	Class	Subclass	Yes	No
	AL							
	AM							
	AN							
	AO							
	AP							
OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)								
	AR	Lowery et al., "Cutting large optics costs with planform bonding", <i>Photonics Spectra</i> , April 1992, pp. 159-161						
	AS	Mark J. Loboda et al., "Understanding hydrogen silsesquioxane-based dielectric film processing", <i>Solid State Technology</i> , May 1998, pp. 1-4						
	AT	"Nanotoxicity of nanomaterials?", <i>Chemistry</i> , Autumn 2003, p. 5						
Examiner			Date Considered					
<p><b>*EXAMINER:</b> Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with your communication to applicant.</p>								